

Item Number	Part Number	Value	MBR	Description	Quantity
1	BD1,BD2, BD3,BD4	CGRM4005-G	COMCHIP	1A/600V SUB SMA	4
2	D2	BAV21W	LiSion TAIWAN-SEM	0.2A/200V SOD-123	1
3	D4	VS1045L-HF	COMCHIP		
4	D5	SBR10U45SP5	DIODES	10A/45V	1
5	D6	CURM105-G	COMCHIP	1A/600V SUB SMA	1
6	L1	MMSZ5258B BZT52B36	LiSion TAIWAN-SEM	36V Zener SOD-123	1
7	FB1,R3A	GAL	GOTREND	330uH	1
8	C1,C2	RTT050000FTP	RALEC	0R 0805 1%	2
9	C3	KM6R8M400F115A	CAPXON	6.8uF/400V 8Φ*12	2
10	C6	0805F10Z500CT	Walsin Samsung Samsung	105/50V 0805 Y5V	1
11	C7	CL21B102KBANNNC		102/50V 0805 X7R	1
12	C4,C5,C5A	CL31B102KHFNNE		102/630V 1206 X7R	1
13	R2,R3	6TPE330MIL CH7331M8810	Tong San Electronic LongView	SANYO 330uF D3L KEMET 330uF	3
14	R4	RTT061005FTP	RALEC	10M 1206 1%	2
15	R5	RTT051203FTP	RALEC	120K 0805 1%	1
16	R6	RTT052552FTP	RALEC	25.5K 0805 1%	1
17	R7	RTT054R70FTP	RALEC	4R7 0805 1%	1
18	R8	RTT0533R0FTP	RALEC	33R 0805 1%	1
19	R9	RTT032001FTP	RALEC	2K 0603 1%	1
20	R10	RTT061R80FTP	RALEC	1R8 1206 1%	1
21	R11	RTT0539R0FTP	RALEC	39R 0805 1%	1
22	R12	RTT052701FTP	RALEC	2.7K 0805 1%	1
23	R13	RTT062203FTP	RALEC	220K 1206 1%	1
24	R14	RTT050000FTP	RALEC	0R 0805 1%	1
25	Q1	P0165A AOU1N60	Chainpower PROMATE	NIKO-SEM 1A/650V AO-SEM 1A/600V	1
26	U1	UCC28700	TI	SOD-23 6PIN	1
27	T1		YUJING AXIS	EPC-13 1.5mH	1
28	F1	263Series	LVT	LITTELFUSE 250V/2A	1
29	USB	USAF-04XN-1XR802-A	Accurate Innotech	USB 2.0	1

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